

# **Universal Input Switchmode Controller**

### **FEATURES**

- 10- to 450-V Input Range
- Current-Mode Control
- 125-mA Output Drive
- Internal Start-Up Circuit
- Internal Oscillator (1 MHz)
- SHUTDOWN and RESET

### **DESCRIPTION**

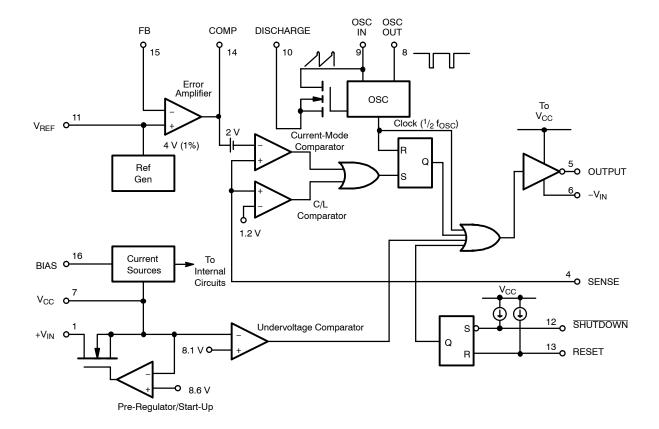
The Si9120 is a BiC/DMOS integrated circuit designed for use in low-power, high-efficiency off-line power supplies. High-voltage DMOS inputs allow the controller to work over a wide range of input voltages (10- to 450-VDC). Current-mode PWM control circuitry is implemented in CMOS to reduce quiescent current to less than 1.5 mA.

A CMOS output driver provides high-speed switching for MOSFET devices with gate charge,  $Q_{\alpha}$ , up to 25 nC, enough

to supply 30 W of output power at 100 kHz. These devices, when combined with an output MOSFET and transformer, can be used to implement single-ended power converter topologies (i.e., flyback and forward).

The Si9120 is available in both standard and lead (Pb)-free 16-pin plastic DIP and SOIC packages which are specified to operate over the industrial temperature range of  $-40\,^{\circ}$ C to  $85\,^{\circ}$ C.

## **FUNCTIONAL BLOCK DIAGRAM**



Applications information, see AN707 and AN708.

Document Number: 70006 S-42042—Rev. H, 15-Nov-04



## **ABSOLUTE MAXIMUM RATINGS**

Voltages Referenced to $-V_{IN}$ (Note: $V_{CC} < +V_{IN} + 0.3 \text{ V}$ )
$V_{CC}\dots \dots 15V$
$+V_{IN}$
Logic Inputs (RESET
SHUTDOWN, OSC IN, OSC OUT)0.3 V to V <sub>CC</sub> + 0.3 V
Linear Input
(FEEDBACK, SENSE, BIAS, $V_{\mbox{\scriptsize REF}})$ 0.3 V to 7 V
HV Pre-Regulator Input Current (continuous) 5 mA <sup>a</sup>
Continuous Output Current (Source or Sink) 125 mA
Storage Temperature
Operating Temperature –40 to 85°C
Junction Temperature (T <sub>J</sub> )

Power Dissipation (Package) <sup>b</sup>	
16-Pin Plastic DIP (J Suffix) <sup>c</sup>	750 mW
16-Pin SOIC (Y Suffix) <sup>d</sup>	900 mW
Thermal Impedance ( $\Theta_{JA}$ )	
16-Pin Plastic DIP	67° C/W
16-Pin SOIC	40°C/W

#### Notes

- Continuous current may be limited by the applications maximum input voltage and the package power dissipation.

  Device mounted with all leads soldered or welded to PC board.
- Derate 6 mW/°C above 25°C.
- Derate 7.2 mW/°C above 25°C.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **RECOMMENDED OPERATING RANGE**

Voltages Referenced to -V <sub>IN</sub>	
V <sub>CC</sub>	$R_OSC$
+V <sub>IN</sub>	Linear Inputs
f <sub>OSC</sub> 40 kHz to 1 MHz	Digital Inputs

SPECIFICATIONS <sup>a</sup>							
		Specific Test Conditions  DISCHARGE = $-V_{IN} = 0 \text{ V}$ , $V_{CC} = 10 \text{ V} + V_{IN} = 300 \text{ V}$ $R_{BIAS} = 390 \text{ k}\Omega$ , $R_{OSC} = 330 \text{ k}\Omega$	TEMPB	LIMITS D Suffix -40 to 85°C			
Parameter	Symbol			WINC	TYPD	MAXC	Unit
Reference							
Output Voltage	V <sub>R</sub>	OSC IN = $-V_{IN}$ (OSC Disabled) R <sub>L</sub> = 10 M $\Omega$	Room Full	3.88 3.82	4.0	4.12 4.14	V
Output Impedancee	Z <sub>OUT</sub>		Room	15	30	45	kΩ
Short Circuit Current	I <sub>SREF</sub>	$V_{REF} = -V_{IN}$	Room	70	100	130	μΑ
Temperature Stabilitye	T <sub>REF</sub>		Full		0.5	1.0	mV/°C
Oscillator					•		
Maximum Frequencye	f <sub>MAX</sub>	R <sub>OSC</sub> = 0	Room	1	3		MHz
		$C_{STRAY} \text{ Pin } 9 \le 5 \text{ pF}$ $R_{OSC} = 330 \text{ k}\Omega$	Room	80	100	120	kHz
Initial Accuracy	fosc	$C_{STRAY} \text{ Pin } 9 \le 5 \text{ pF}$ $R_{OSC} = 150 \text{ k}\Omega$	Room	160	200	240	KHZ
Voltage Stability	Δf/f	$\Delta f/f = f(13.5 \text{ V}) - f(9.5 \text{ V}) / f(9.5 \text{ V})$	Room		10	15	%
Temperature Coefficiente	T <sub>OSC</sub>		Full		200	500	ppm/°C
Error Amplifier							
Feedback Input Voltage	V <sub>FB</sub>	FB Tied to COMP OSC IN = - V <sub>IN</sub> (OSC Disabled)	Room	3.92		4.08	V
Input BIAS Current	I <sub>FB</sub>	OSC IN = $-V_{IN}$ , $V_{FB} = 4 V$	Room		25	500	nA
Input OFFSET Voltage	Vos	OSC IN = - V <sub>IN</sub>	Room		± 15	± 40	mV
Open Loop Voltage Gaine	A <sub>VOL</sub>	OSC IN = - V <sub>IN</sub>	Room	60	80		dB
Unity Gain Bandwidthe	BW	OSC IN = $-V_{IN}$	Room	1.0	1.5		MHz

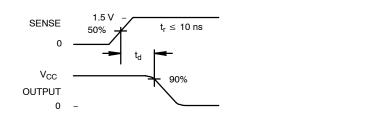


SPECIFICATIONS <sup>a</sup>								
		Specific Test Conditions $DISCHARGE = -V_{IN} = 0 V,$		LIMITS D Suffix -40 to 85°C				
Parameter	Symbol	$V_{CC} = 10 \text{ V} + V_{IN} = 300 \text{ V}$ $R_{BIAS} = 390 \text{ k}\Omega, R_{OSC} = 330 \text{ k}\Omega$	TEMPB	WINC	TYPD	MAXC	Unit	
Error Amplifier (Cont'd)			•					
Dynamic Output Impedance <sup>e</sup>	Z <sub>OUT</sub>	Error Amp configured for 60 dB gain	Room		1000	2000	Ω	
Output Current	Jan	Source V <sub>FB</sub> = 3.4 V	Room		-2.0	-1.4	mA	
Output Gurrent	lout	Sink V <sub>FB</sub> = 4.5 V	Room	0.12	0.15		IIIA	
Power Supply Rejection	PSRR	$9.5 \text{ V} \le \text{V}_{CC} \le 13.5 \text{ V}$	Room	50	70		dB	
Current Limit								
Threshold Voltage	V <sub>SOURCE</sub>	V <sub>FB</sub> = 0 V	Room	1.0	1.2	1.4	V	
Delay to Output <sup>e</sup>	t <sub>d</sub>	V <sub>SENSE</sub> = 1.5 V, See Figure 1	Room		100	150	ns	
Pre-Regulator/Start-Up								
Input Voltage	+V <sub>IN</sub>	I <sub>IN</sub> = 10 μA	Room	450			V	
Input Leakage Current	+l <sub>IN</sub>	$V_{CC} \ge 9.4 V$	Room			10	μΑ	
V <sub>CC</sub> Pre-Regulator Turn-Off Threshold Voltage	V <sub>REG</sub>	I <sub>PRE-REGULATOR</sub> = 10 μA	Room	7.8	8.6	9.4		
Undervoltage Lockout	V <sub>UVLO</sub>		Room	7.0	8.1	8.9	V	
V <sub>REG</sub> -V <sub>UVLO</sub>	V <sub>DELTA</sub>		Room	0.3	0.6			
Supply								
Supply Current	Icc	C <sub>L</sub> = 500 pF at Pin 5	Room		0.85	1.5	mA	
Bias Current	I <sub>BIAS</sub>		Room	10	15	20	μΑ	
Logic			•	,	·U	•		
SHUTDOWN Delaye	t <sub>SD</sub>	C <sub>L</sub> = 500 pF, V <sub>SENSE</sub> = -V <sub>IN</sub> See Figure 2	Room		50	100		
SHUTDOWN Pulse Widthe	t <sub>SW</sub>		Room	50				
RESET Pulse Widthe	t <sub>RW</sub>	See Figure 3	Room	50			ns	
Latching Pulse Width SHUTDOWN and RESET Low <sup>e</sup>	t <sub>LW</sub>	3	Room	25				
Input Low Voltage	V <sub>IL</sub>		Room			2.0	V	
Input High Voltage	V <sub>IH</sub>		Room	8.0			٧	
Input Current Input Voltage High	I <sub>IH</sub>	V <sub>IN</sub> = 10 V	Room		1	5	μА	
Input Current Input Voltage Low	I <sub>IL</sub>	$V_{IN} = 0 V$	Room	-35	-25		μΑ	
Output								
Output High Voltage	V <sub>OH</sub>	I <sub>OUT</sub> = -10 mA	Room Full	9.7 9.5				
Output Low Voltage	V <sub>OL</sub>	I <sub>OUT</sub> = 10 mA	Room Full			0.3 0.5	V	
Output Resistance	R <sub>OUT</sub>	I <sub>OUT</sub> = 10 mA, Source or Sink	Room Full		20 25	30 50	Ω	
Rise Time <sup>e</sup>	t <sub>r</sub>	C <sub>L</sub> = 500 pF	Room		40	75	ns	
Fall Time <sup>e</sup>	t <sub>f</sub>	<del>-</del> .	Room	40	75			

- Notes
  a. Refer to PROCESS OPTION FLOWCHART for additional information.
  b. Room = 25°C, Cold and Hot = as determined by the operating temperature suffix.
  c. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
  d. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
  e. Guaranteed by design, not subject to production test.
  a. 250 V ≤ +V<sub>IN</sub> 380 V place a 10-kΩ, <sup>1</sup>/<sub>4</sub>-W resistor in series with a +V<sub>IN</sub> (Pin1).
  380 V ≤ +V<sub>IN</sub> 450 V place a 15-kΩ, <sup>1</sup>/<sub>4</sub>-W resistor in series with a +V<sub>IN</sub> (Pin1).
  Connect a 0.01-μfd capacitor between +V<sub>IN</sub> (Pin 1) and -V<sub>IN</sub> (Pin 6).



## **TIMING WAVEFORMS**



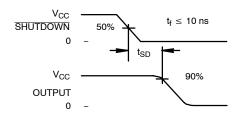


FIGURE 1. FIGURE 2.

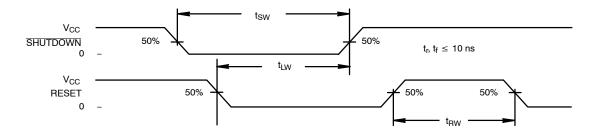
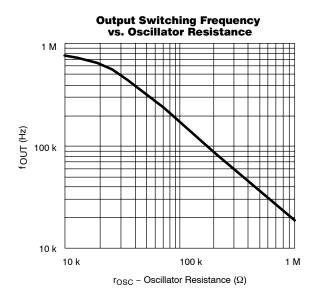
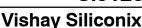


FIGURE 3.

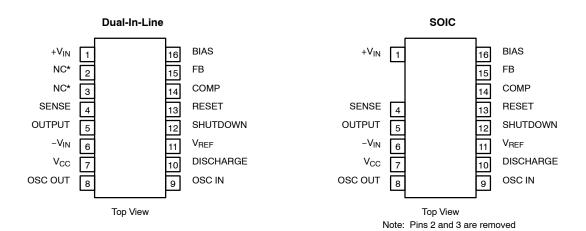
## TYPICAL CHARACTERISTICS







## PIN CONFIGURATIONS AND ORDERING INFORMATION



ORDERING INFORMATION				
Part Number	Temperature Range Packa			
Si9120DY				
Si9120DY-T1		SOIC-16		
Si9120DY-T1—E3	−40 to 85°C			
Si9120DJ		PDIP-16		
Si9120DJ—E3		PDIP-16		

## **DETAILED DESCRIPTION**

## Pre-Regulator/Start-Up Section

Due to the low quiescent current requirement of the Si9120 control circuitry, bias power can be supplied from the unregulated input power source, from an external regulated low-voltage supply, or from an auxiliary "bootstrap" winding on the output inductor or transformer.

When power is first applied during start-up,  $+V_{IN}$  (pin 1) will draw a constant current. The magnitude of this current is determined by a high-voltage depletion MOSFET which is connected between  $+V_{IN}$  and  $V_{CC}$  (pin 7). This start-up circuitry provides initial power to the IC by charging an external bypass capacitance connected to the  $V_{CC}$  pin. The constant current is disabled when  $V_{CC}$  exceeds 8.6 V. If  $V_{CC}$  is not forced to exceed the 8.6-V threshold, then  $V_{CC}$  will be regulated to a nominal value of 8.6 V by the pre-regulator circuit.

As the supply voltage rises toward the normal operating conditions, an internal undervoltage (UV) lockout circuit keeps the output driver disabled until  $V_{CC}$  exceeds the undervoltage lockout threshold (typically 8.1 V). This guarantees that the

control logic will be functioning properly and that sufficient gate drive voltage is available before the MOSFET turns on. The design of the IC is such that the undervoltage lockout threshold will be at least 300 mV less than the pre-regulator turn-off voltage. Power dissipation can be minimized by providing an external power source to  $V_{CC}$  such that the constant current source is always disabled.

**Note:** When driving large MOSFETs at high frequency without a bootstrap  $V_{CC}$  supply, power dissipation in the pre-regulator may exceed the power rating of the IC package. For operation of  $+V_{IN}>250$  V, a  $10-k\Omega$ ,  $^{1}/_{4}$ -W resistor should be placed in series with  $+V_{IN}$  (Pin 1). For  $+V_{IN}>380$  V, a  $15-k\Omega$ ,  $^{1}/_{4}$ -W resistor is recommended.

## **BIAS**

To properly set the bias for the Si9120, a 390-k $\Omega$  resistor should be tied from BIAS (pin 16) to  $-V_{IN}$  (pin 6). This determines the magnitude of bias current in all of the analog sections and the pull-up current for the  $\overline{SHUTDOWN}$  and RESET pins. The current flowing in the bias resistor is nominally 15  $\mu$ A.



## **DETAILED DESCRIPTION (CONT'D)**

#### **Reference Section**

The reference section of the Si9120 consists of a temperature compensated buried zener and trimmable divider network. The output of the reference section is connected internally to the non-inverting input of the error amplifier. Nominal reference output voltage is 4 V. The trimming procedure that is used on the Si9120 brings the output of the error amplifier (which is configured for unity gain during trimming) to within  $\pm 2\%$  of 4 V. This compensates for input offset voltage in the error amplifier.

The output impedance of the reference section has been purposely made high so that a low impedance external voltage source can be used to override the internal voltage source, if desired, without otherwise altering the performance of the device.

## **Error Amplifier**

Closed-loop regulation is provided by the error amplifier, which is intended for use with "around-the-amplifier" compensation. A MOS differential input stage provides for high input impedance. The noninverting input to the error amplifier ( $V_{\text{REF}}$ ) is internally connected to the output of the reference supply and should be bypassed with a small capacitor to ground.

## **Oscillator Section**

The oscillator consists of a ring of CMOS inverters, capacitors, and a capacitor discharge switch. Frequency is set by an external resistor between the OSC IN and OSC OUT pins. (See Typical Characteristics for details of resistor value vs. frequency.) The DISCHARGE pin should be tied to  $-V_{IN}$  for normal internal oscillator operation. A frequency divider in the logic section limits switch duty cycle to  $\leq$  50% by locking the switching frequency to one half of the oscillator frequency.

## **SHUTDOWN** and RESET

SHUTDOWN (pin 12) and RESET (pin 13) are intended for overriding the output MOSFET switch via external control logic. The two inputs are fed through a latch preceding the output switch. Depending on the logic state of RESET. SHUTDOWN can be either a latched or unlatched input. The output is off whenever SHUTDOWN is low. By simultaneously having SHUTDOWN and RESET low, the latch is set and SHUTDOWN has no effect until RESET goes high. See Table TABLE 1.

Both pins have internal current source pull-ups and should be left disconnected when not in use. An added feature of the current sources is the ability to connect a capacitor and an open-collector driver to the SHUTDOWN or RESET pins to provide variable shutdown time.

TABLE 1. TRUTH TABLE FOR SHUTDOWN AND RESET PINS					
SHUTDOWN	RESET	OUTPUT			
Н	Н	Normal Operation			
Н	_₹_	Normal Operation (No Change)			
L	Н	Off (Not Latched)			
L	L	Off (Latched)			
		Off (Latched—No Change)			

#### **Output Driver**

The push-pull driver output has a typical on-resistance of  $20-\Omega$  maximum switching times are specified at 75 ns for a 500-pF load. This is sufficient to directly drive MOSFETs such as the IRF820, BUZ78 or BUZ80. Larger devices can be driven, but switching times will be longer, resulting in higher switching losses.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?70006">http://www.vishay.com/ppg?70006</a>.